BGF108C

7 Channel LCD Filter Array with ESD Protection

Small Signal Discretes



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BGF108	C
Revision	n History: 2008-12-12, V2.0
Previous	s Version:2008-10-14, V1.0
Page	Subjects (major changes since last revision)
All	Preliminary status removed



7 Channel LCD Filter Array with ESD Protection

Feature

- 7 channel integrated RC filter array
- ESD protection according to IEC61000-4-2 of 15 kV contact discharge on all IOs
- Wafer Level Package with SnAgCu solder balls
- 400 μm solder ball pitch
- · RoHS and WEEE compliant package
- · Improved package for increased drop test reliability



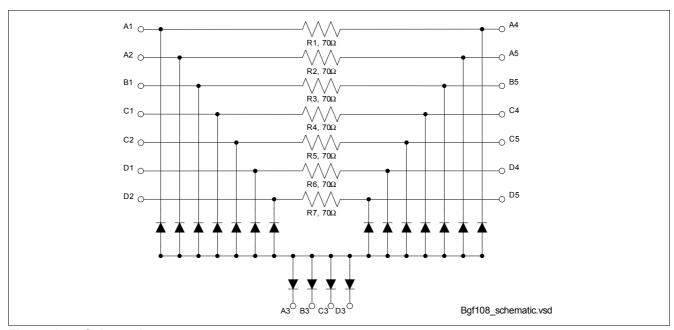


Figure 1 Schematic

Description

BGF108C is a 7 channel RC filter array to provide attenuation of undesired signals in the 800 - 2000 MHz range. All pins are protected against ESD of 15 kV according to IEC61000-4-2 (contact discharge). The wafer level package is a green package with a size of only 1.95 mm x 2.07 mm and a total height of 0.60 mm. The package has been improved for increased drop test reliability.

Туре	Package	Marking	Chip
BGF108C	WLP-18-4	GF108C	N0715



Table 1 Maximum Ratings

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Voltage at all pins to GND	V_{P}	0		5	V	
Operating temperature range	T_{OP}	-40		+85	°C	
Storage temperature range	T_{STG}	-65		+150	°C	
Summed up input power for all pins	P_{IN}			60	mW	T _S < 70 °C
Electrostatic discharge according to IEC61000-4-2 ¹⁾ at all pins	V_{E}	-15		15	kV	

¹⁾ Contact discharge

Table 2 Electrical Characteristics¹⁾

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Series Resistors R_1 R_{10}	R	56	70	84	Ω	
Leakage current of each line to GND	I_{R}		1 2	100 1000	nA	$V_{\rm R}$ = 3 V $V_{\rm R}$ = 5 V
Breakdown Voltage of each line to GND	$V_{(BR)}$	7	8.2		V	$I_{(BR)}$ = 1 mA
Line capacitance of each line to GND	C_{T}		27 17	30	pF	$V_{\rm R}$ = 0 V $V_{\rm R}$ = 3 V

¹⁾ at T_A = 25 °C

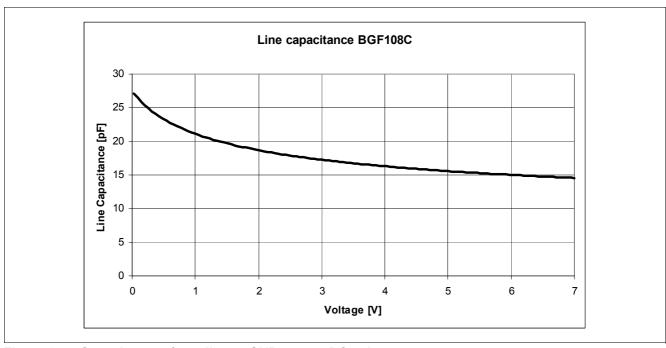


Figure 2 Capacitance of one line to GND versus DC voltage



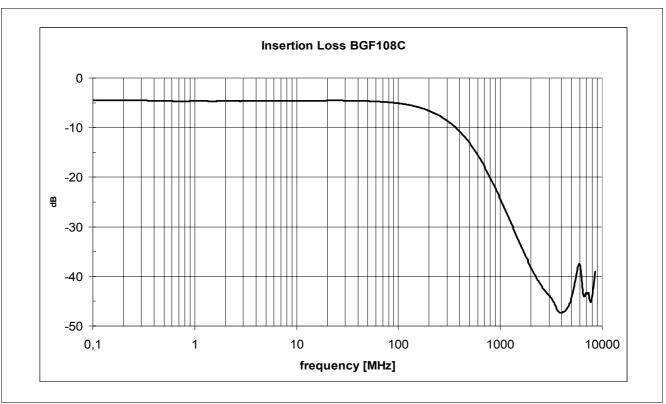


Figure 3 Typical filter characteristics of one filter channel ($Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω , $V_{\rm R}$ = 0 V)

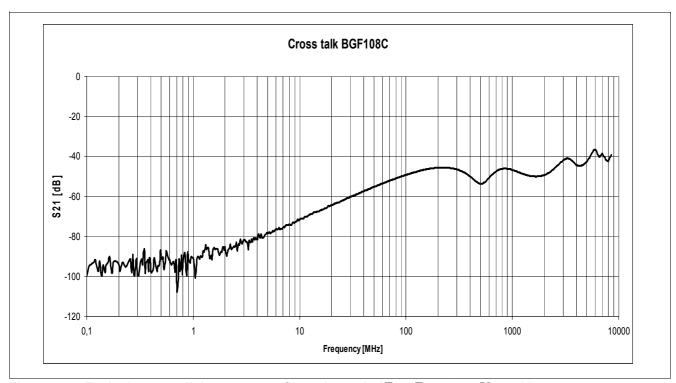


Figure 4 Typical cross talk between two filter channels ($Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω , $V_{\rm R}$ = 0 V)



Package Outline

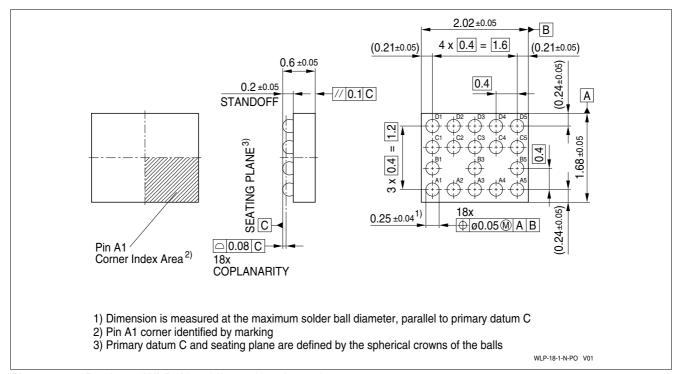


Figure 5 Package WLP-18-4 (dimensions in mm)

Tape and reel specification

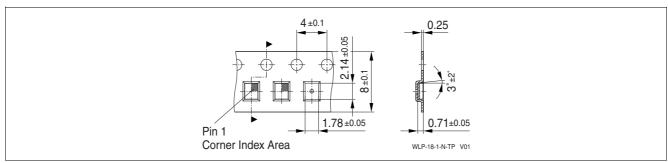


Figure 6 Tape for WLP-18-4 (dimensions in mm)